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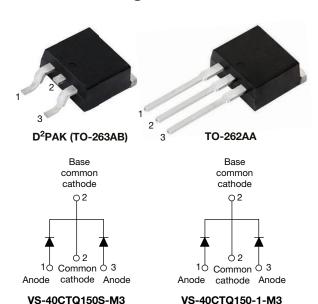
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COMPLIANT

HALOGEN

FREE

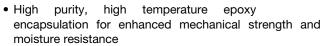
High Performance Schottky Rectifier, 2 x 20 A



PRIMARY CHARACTERISTICS						
I _{F(AV)}	2 x 20 A					
V _R	150 V					
V _F at I _F	0.71 V					
I _{RM}	15 mA at 125 °C					
T _J max.	175 °C					
E _{AS}	1 mJ					
Package	D ² PAK (TO-263AB), TO-262AA					
Circuit configuration	Common cathode					

FEATURES

- · Very low forward voltage drop
- 175 °C T_{.I} operation
- Center tap TO-220 package
- High frequency operation



- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

The VS-40CTQ... center tap Schottky rectifier has been optimized for very low forward voltage drop, with moderate leakage. The proprietary barrier technology allows for reliable operation up to 175 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I _{F(AV)}	Rectangular waveform	40	Α			
V _{RRM}		150	V			
I _{FSM}	t _p = 5 μs sine	1500	Α			
V _F	20 A _{pk} , T _J = 125 °C (per leg)	0.71	V			
T _J		-55 to +175	°C			

VOLTAGE RATINGS							
PARAMETER	SYMBOL	VS-40CTQ150S-M3 VS-40CTQ150-1-M3	UNITS				
Maximum DC reverse voltage	V _R	150	V				
Maximum working peak reverse voltage	V_{RWM}	150	V				



VS-40CTQ150S-M3, VS-40CTQ150-1-M3

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ABSOLUTE MAXIMUM RATINGS								
PARAMETER		SYMBOL	TEST CONDITIONS		VALUES	UNITS		
Maximum average forward per leg		1	50 % duty ovalo at T ₋ = 140 %	C rootangular wayoform	20			
current, see fig. 5	per device	I _{F(AV)}	50 % duty cycle at T_C = 140 °C, rectangular waveform		40			
Maximum peak one cycle non-repetitive surge current per leg, see fig. 7			5 μs sine or 3 μs rect. pulse	Following any rated	1500	А		
		I _{FSM}	10 ms sine or 6 ms rect. pulse	load condition and with rated V _{RRM} applied	250			
Non-repetitive avalanche energy	y per leg	E _{AS}	T _J = 25 °C, I _{AS} = 1.5 A, L = 0.9 mH		1.0	mJ		
Repetitive avalanche current pe	Repetitive avalanche current per leg		Current decaying linearly to z Frequency limited by T_J maxitypical	1.5	Α			

ELECTRICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CO	NDITIONS	VALUES	UNITS			
		20 A	T _{.1} = 25 °C	0.93	V			
Maximum forward voltage drop per leg See fig. 1	V _{FM} ⁽¹⁾	40 A	1j = 25 C	1.16				
	V _{FM} (')	20 A	T _{.1} = 125 °C	0.71				
		40 A	1j = 125 C	0.85				
Maximum reverse leakage current per leg	I _{RM} ⁽¹⁾	T _J = 25 °C	V _R = Rated V _R	50	μΑ			
See fig. 2		T _J = 125 °C	v _R = nateu v _R	15	mA			
Maximum junction capacitance per leg	C _T	V _R = 5 V _{DC} (test signal range 100 kHz to 1 MHz), 25 °C		450	pF			
Typical series inductance per leg	L _S	Measured lead to lead 5 r	8.0	nΗ				
Maximum voltage rate of change	dV/dt	Rated V _R	10 000	V/µs				

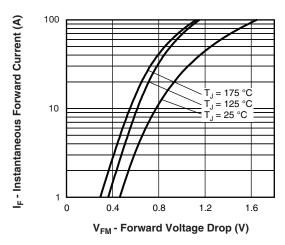
Note

 $^{(1)}$ Pulse width < 300 μ s, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum junction and storage temperatu	ire range	T _J , T _{Stg}		-55 to +175	°C		
Maximum thermal resistance, junction to case per leg		D	DC operation See fig. 4	1.5			
Maximum thermal resistance, junction to case per package		- R _{thJC}	DC operation	0.75	°C/W		
Typical thermal resistance, case to heatsi	nk	R _{thCS}	Mounting surface, smooth and greased	0.5			
Approximate weight				2	g		
Approximate weight				0.07	OZ.		
Mounting torque	Mana Mana Mana Mana Mana Mana Mana Mana		Non-lubricated threads	6 (5)	kgf · cm		
maximum			Non-lubilicated tilledus	12 (10)	(lbf \cdot in)		
Marking device			Case style D ² PAK (TO-263AB)	40CTC	Q150S		
			Case style TO-262AA	40CTC	150-1		



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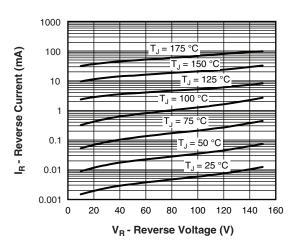


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

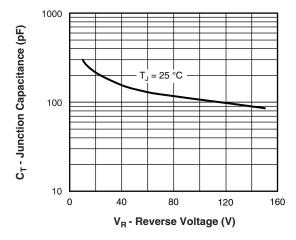


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

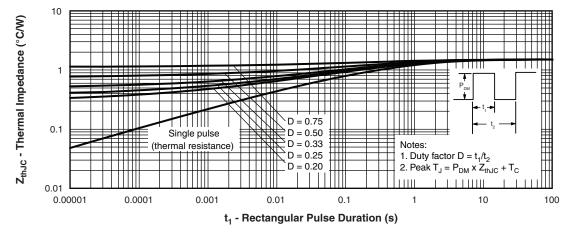


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics



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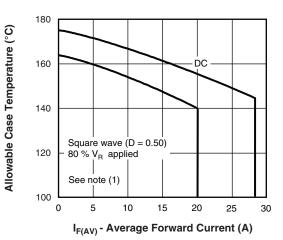


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

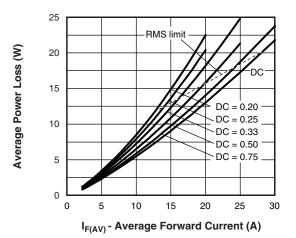


Fig. 6 - Forward Power Loss Characteristics

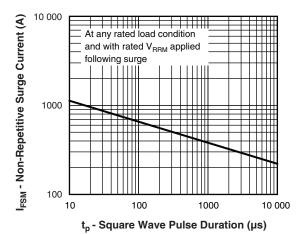


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

Note

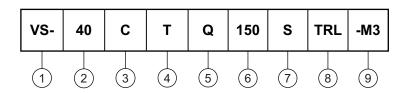
 $^{(1)}$ Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC};$ $Pd = forward power loss = I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6); $Pd_{REV} = inverse$ power loss = $V_{R1} \times I_R$ (1 - D); I_R at $V_{R1} = 80~\%~V_R$ applied

VS-40CTQ150S-M3, VS-40CTQ150-1-M3

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ORDERING INFORMATION TABLE

Device code



- 1 Vishay Semiconductors product
- Current rating (40 A)
- Circuit configuration:

C = common cathode

- **4** T = TO-220
- 5 Schottky "Q" series
- 6 Voltage rating (150 = 150 V)
- 7 • S = D^2 PAK (TO-263AB)
 - -1 = TO-262AA
- 8 • None = tube (50 pieces)
 - TRL = tape and reel (left oriented for D²PAK (TO-263AB) only)
 - TRR = tape and reel (right oriented for D²PAK (TO-263AB) only)
- 9 -M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

ORDERING INFORMATION (Example)							
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION					
VS-40CTQ150S-M3	50	Antistatic plastic tubes					
VS-40CTQ150STRL-M3	800	13" diameter plastic tape and reel					
VS-40CTQ150STRR-M3	800	13" diameter plastic tape and reel					
VS-40CTQ150-1-M3	50	Antistatic plastic tubes					

LINKS TO RELATED DOCUMENTS						
Dimensions	D ² PAK (TO-263AB)	www.vishay.com/doc?96164				
Differsions	TO-262AA	www.vishay.com/doc?96165				
Ded and the lefe maller	D ² PAK (TO-263AB)	www.vishay.com/doc?95444				
Part marking information	TO-262AA	www.vishay.com/doc?95443				
Packaging information		www.vishay.com/doc?96424				
SPICE model		www.vishay.com/doc?95434				



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D²PAK

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES	NOTES SYMBOL MILLIMETERS INCHES		OTES	MILLIMETERS		HES	NOTES
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES	NOTES	STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			Е	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100	BSC	
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB

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TO-262

DIMENSIONS in millimeters and inches



SYMBOL	MILLIN	METERS	INC	INCHES			
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES		
Α	A 4.06		0.160	0.190			
A1	2.03	3.02	0.080	0.119			
b	0.51	0.99	0.020	0.039			
b1	0.51	0.89	0.020	0.035	4		
b2	1.14	1.78	0.045	0.070			
b3	1.14	1.73	0.045	0.068	4		
С	0.38	0.74	0.015	0.029			
c1	0.38	0.58	0.015	0.023	4		
c2	1.14	1.65	0.045	0.065			
D	8.51	9.65	0.335	0.380	2		
D1	6.86	8.00	0.270	0.315	3		
E	9.65	10.67	0.380	0.420	2, 3		
E1	7.90	8.80	0.311	0.346	3		
е	2.54 BSC		0.100	BSC			
L	13.46	14.10	0.530	0.555			
L1	-	1.65	-	0.065	3		
L2	3.36	3.71	0.132	0.146			

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- 5) Controlling dimension: inches
- (6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum), D1 (minimum) and L2 where dimensions derived the actual package outline

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